NOTE:
For AMC1204: C9, C10, D1, D2 are DNP
For AMC1304: R1, R4, D1, D2 are DNP

Symbol

Texas Instruments
TIDM-SERVO DRIVE
Industrial Drive Development Kit
SD Current Sense - 2 phase
IDDK
Texas Instruments
TIDM-SERVO DRIVE
Industrial Drive Development Kit
SinCos Interface

IDDK
01/06/2015

History:
[R1] ---> [R3]:
- DM1 removed
- 5V replaced with 3V3 and 5V removed
- VR1 replaced with R16 and R17
- OPA134 replaced with OPA2134
Symbol

3 AC-L
5 Earth FUSE
4 AC-N

AC-PwrEntry-Filt-ret-LMMeas

Texas Instruments
TIDM-SERVO DRIVE
Industrial Drive Development Kit
AC-Power - Filter

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NOTE: - Pins 2 and 4 are NC
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